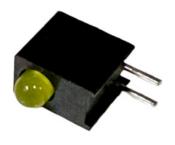
Lamp With Holder Assembly Multicomp PRO



RoHS **Compliant**



Features

- Designed for ease in circuit board assembly.
- Black case enhance contrast ratio.
- Solid state light source.
- Reliable and rugged.
- 3mm diameter package.

Applications

- TV set
- Monitor
- Telephone
- Computer
- Circuit board

Specification

Chip material : AllnGaP Emitted colour : Yellow

: Yellow Diffused Lens Appearance

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Yellow	Unit		
Power Dissipation	Po	75	mW		
Forward Current	lF	30	mA		
Peak Forward Current*1	I FP	50	mA		
Reverse Voltage	VR	5	V		
Operating Temperature	Topr	-40°C To +85°C			
Storage Temperature	Tstg	-40°C To +85°C			
Soldering Temperature	Tsol	260°C (for 5 seconds)			

^{*1}Condition for IFP is pulse of 1/10 duty and 0.1msec width.

Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Test Conditions	Colour	Min.	Тур.	Max	Unit
Forward Voltage	VF	I=20mA	Yellow	1.8		2.4	V
Luminous Intensity	lv	I=20mA		20		80	mcd
Reverse Current	IR	V _R =1V		_	_	10	μΑ
Dominate Wave Length	λd	IF=20mA		585	590	595	nm
Spectral Line Half-width	Δλ			_	30	_	nm
Viewing Angle	201/2		_	70	_	Deg.	

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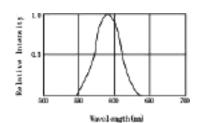


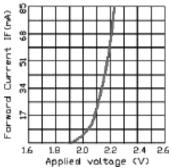
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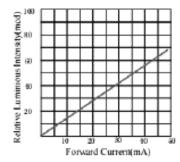


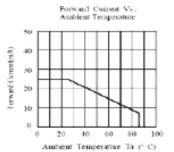
Typical Electrical/Optical Characteristics Curves

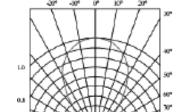
Yellow



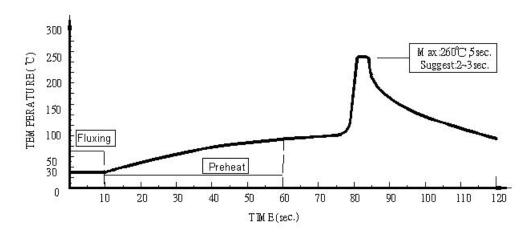








Dip Soldering



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Lamp With Holder Assembly Multicomp PRO

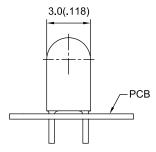


- 1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temperature.
- 4. Avoid rapid cooling during temperature ramp-down process
- 5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

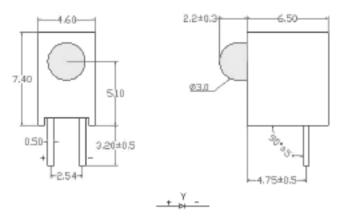
Iron Soldering

A: Max: 350°C Within 3 sec. One time only.

B: The products of 3mm without flange, welding condition of flat plate PCB Max: 350°C Within 2 sec. One time only



Dimensions



Notes

- 1. Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 2. Lead spacing is measured where the leads emerge from the package.
- 3. Specifications are subject to change without notice.

Part Number Table

Description	Part Number	
1 LED Lamp With Holder, Yellow, 4.6 × 7.4 × 6.5mm, 30mA	BL-33Y-1	

Dimensions: Millimetres (Inches)

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